



Precision Analog Microcontroller, 12-Bit Analog I/O, ARM7TDMI MCU with Enhanced IRQ Handler

Silicon Anomaly

ADuC7023

This anomaly list describes the known bugs, anomalies, and workarounds for the ADuC7023 MicroConverter® Revision A silicon. The anomalies listed apply to all ADuC7023 packaged material branded as follows:

First Line ADuC7023

Third Line xxx (revision identifier)

Analog Devices, Inc., is committed, through future silicon revisions, to continuously improve silicon functionality. Analog Devices tries to ensure that these future silicon revisions remain compatible with your present software/systems by implementing the recommended workarounds outlined here.

ADuC7023 FUNCTIONALITY ISSUES

Silicon Revision Identifier	Kernel Revision Identifier	Chip Marking	Silicon Status	Anomaly Sheet	No. of Reported Issues
		All silicon branded xxx	Released	Rev. 0	5

ADuC7023 PERFORMANCE ISSUES

Silicon Revision Identifier	Kernel Revision Identifier	Chip Marking	Silicon Status	Anomaly Sheet	No. of Reported Issues
		All silicon branded xxx	Released	Rev. 0	3

Rev. 0

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FUNCTIONALITY ISSUES

Table 1. ADC Conversion—Single Software Edge Triggered Mode [er001]

Background	The ADC can be set to single software conversion mode by setting ADCCON[2:0] = 011b. The ADC can also be configured in continuous software conversion mode by setting ADCCON[2:0] = 100b. The ADC is then triggered by the $\overline{\text{CONV}}_{\text{START}}$ pin. ADCCON[13] configures the $\overline{\text{CONV}}_{\text{START}}$ pin for level or edge triggered mode. When ADCCON[13] = 0, a low level on the $\overline{\text{CONV}}_{\text{START}}$ pin triggers an ADC conversion. When ADCCON[13] = 1, a rising edge on the $\overline{\text{CONV}}_{\text{START}}$ pin triggers an ADC conversion.
Issue	After a single conversion when in single software conversion mode, ADCCON[2:0] changes to 000b automatically. Extra ADC triggers can occur if the $\overline{\text{CONV}}_{\text{START}}$ pin is low and ADCCON[13] = 0.
Workaround	When using single conversion mode, set ADCCON[13] = 1 to configure the $\overline{\text{CONV}}_{\text{START}}$ pin for edge-based triggered mode.
Related Issues	None.

Table 2. ADC Conversion— $\overline{\text{CONV}}_{\text{START}}$ Edge Triggered Mode [er002]

Background	An ADC conversion can be triggered by a rising edge on the $\overline{\text{CONV}}_{\text{START}}$ if ADCCON[13] is set to 1, or by a low level on the $\overline{\text{CONV}}_{\text{START}}$ pin if ADCCON[13] is cleared to 0.
Issue	ADC conversions triggered by a rising edge of the $\overline{\text{CONV}}_{\text{START}}$ are not reliable.
Workaround	Use PLA conversion mode instead to implement an edge triggered-based ADC conversion.
Related Issues	None.

Table 3. ADC Conversion—PLA Edge Triggered Mode [er003]

Background	An ADC conversion can be set to PLA positive edge triggered mode by setting ADCCON[13] = 1 and ADCCON[2:0] = 101. Clearing ADCCON[13] enables PLA low level triggered mode.
Issue	An ADC conversion by PLA edge triggered mode is not reliable.
Workaround	Configure the PLA element output through another PLA flip-flop with ULCK as its clock. This ensures that the ADC is triggered by the PLA edge when the clock divide (CD) bits in POWCON0 is less than 5.
Related Issues	None.

Table 4. SPI Bit Rate Issue [er004]

Background	In SPI master mode, polarity and phase of the clock are controlled by the SPICON register, and the bit rate is defined in the SPIDIV register. The maximum speed of the SPI clock is independent from the clock divider bits.
Issue	When SPICON[6] = 0, transfers are initiated in master mode by reading the SPIRX register. When SPICON[6] = 0, SPIDIV must not be set to a value greater than 0x2 because bytes may be lost.
Workaround	Set the SPIDIV register to a value less than or equal to 0x32. Alternatively, set SPICON[6] = 1 to initiate transfers on a write to SPITX. In this mode, all values of SPIDIV are valid.
Related Issues	None.

Table 5. Internal Pull-Up Resistor on P2.0 Cannot Be Disabled on 40-Lead Package [er005]

Background	The GPIO has internal weak pull-up resistors that can be disabled by setting GPxPAR. P2.0 can also be configured as Differential Analog Input 12, ADC12, by setting GP2CON = 0x1 (Bit 0 = 1 and Bit 1 = 0).
Issue	When P2.0 is set as Analog Input ADC12, its internal pull-up resistor cannot be disabled by setting GP2PAR. The input leakage is large and affects the ADC result when this channel is selected.
Workaround	Select other ADC channels through the ADCCP MMR.
Related Issues	None.

PERFORMANCE ISSUES

Table 6. JTAG Clock Limitation [pr001]

Background	The JTAG clock speed is limited.
Issue	JTAG speed requires $TCK < UCLK / ((2^{CD}) \times 6)$; that is, TCK should be changed according to how CD is set. If TCK is greater than the limitation, then JTAG cannot download until the JTAG pod (programming device) is at the correct TCK speed.
Workaround	This must be set up manually. The default kernel setting for the CPU clock is $CD = 3$ (5.22 MHz). Therefore, a JTAG clock speed limitation of 800 kHz or less must be maintained.
Related Issues	None.

Table 7. ADC and DAC Reference Selection Limitation [pr002]

Background	The ADuC7023 provides an on-chip band gap reference of 2.5 V that can be used for the ADC and DACs. This internal reference also appears on the V_{REF} pin. When using the internal reference, a 0.47 μ F capacitor must be connected from the external V_{REF} pin to AGND to ensure stability and fast response during ADC conversions.
Issue	When $REFCON = 0x00$, the internal 2.5 V reference is unstable; that is, when ADC uses the external reference ($REFCON = 0x00$) and the DACs use the internal 2.5 V reference ($DACxCON[1:0] = 10b$ or $01b$), then the DAC output is unstable.
Workaround	The ADC and DACs can use the same external reference by setting $REFCON = 0x01$ and $DACxCON[1:0] = 10b$. The external reference should be capable of sourcing more than 10 μ A.
Related Issues	None.

Table 8. P0.0/P0.1/P0.2/P0.3 Limitations When Used in GPIO or JTAG Modes [pr003]

Background	The ADuC7023 multiplexes the JTAG interface pins, nTRST, TDO, TDI, and TCK, with P0.0, P0.1, P0.2, and P0.3, respectively. During any reset sequence, the level on the P0.0 pin is sampled by the internal kernel program, which determines the mode of operation that the ADuC7023 part will enter after the reset sequence: If $P0.0/nTRST/BM = 0$ and Flash Address $0x80014 = 0xFFFFFFFF$, the part enters I ² C download mode. P0.1, P0.2, and P0.3 default as input pins with a weak internal pull-up resistor enabled. If $P0.0/nTRST/BM = 0$ and Flash Address $0x80014 \neq 0xFFFFFFFF$, the part enters normal operating mode and P0.0, P0.1, P0.2, and P0.3 are normal GPIO or programmable logic array (PLA) pins. If $P0.0/nTRST/BM = 1$, the part enters JTAG programming/debug mode and P0.0, P0.1, P0.2, and P0.3 are JTAG pins.
Issue	User code should not write to the P0.1, P0.2, or P0.3 pins when the part is in JTAG programming/debug mode. If user code toggles any of these pins, JTAG debug pods will not be able to connect to the ADuC7023. If this happens, the user should ensure that Flash Address $0x80014$ is erased to allow the reprogramming of the part through the I ² C interface. The user must be very careful when changing the mode of operation of the P0.0 to P0.3 pins. If these pins are incorrectly configured, then it may not be possible to reprogram the part again either via the JTAG interface or via the I ² C download interface if Flash Address $0x80014$ is not erased.
Workaround	User code should implement a routine for erasing Flash Location $0x80014$. It should be possible to call this routine in the end users application if it is deemed necessary to reprogram the flash area. When debugging the part via JTAG, Flash Location $0x80014$ should be set to $0xFFFFFFFF$. A simple definition at Vector Address $0x80014$ in the project start-up file can implement this, that is: $DCD 0xFFFFFFFF$. This definition allows the part to be mass erased via the I ² C download interface if P0.1, P0.2, or P0.3 is accidentally written to by user code.
Related Issues	None.

SECTION 1. ADUC7023 FUNCTIONALITY ISSUES

Reference Number	Description	Status
er001	ADC conversion—single software edge triggered mode.	Open.
er002	ADC conversion—CONV _{START} edge triggered mode.	Open
er003	ADC conversion —PLA edge triggered mode.	Open
er004	SPI bit rate issue.	Open.
er005	Internal pull-up resistor on P2.0 cannot be disabled on 40-lead package.	Open.

SECTION 2. ADUC7023 PERFORMANCE ISSUES

Reference Number	Description	Status
pr001	JTAG clock speed is limited.	Open.
pr002	ADC and DAC reference selection limitation.	Open.
pr003	P0.0/P0.1/P0.2/P0.3 limitations when used in GPIO or JTAG modes.	Open.